



MM74HCT540, Inverting Octal 3-STATE Buffer MM74HCT541, Octal 3-STATE Buffer

Features

- TTL input compatible
- Typical propagation delay: 12ns
- 3-STATE outputs for connection to system buses
- Low quiescent current: 80µA
- Output current: 6mA (Min.)

General Description

The MM74HCT540 and MM74HCT541 3-STATE buffers utilize advanced silicon-gate CMOS technology and are general purpose high speed inverting and non-inverting buffers. They possess high drive current outputs which enable high speed operation even when driving large bus capacitances. These circuits achieve speeds comparable to low power Schottky devices, while retaining the low power consumption of CMOS. Both devices are TTL input compatible and have a fanout of 15 LS-TTL equivalent inputs.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

The MM74HCT540 is an inverting buffer and the MM74HCT541 is a non-inverting buffer. The 3-STATE control gate operates as a two-input NOR such that if either $\overline{\text{G1}}$ or $\overline{\text{G2}}$ are HIGH, all eight outputs are in the high-impedance state.

In order to enhance PC board layout, the MM74HCT540 and MM74HCT541 offers a pinout having inputs and outputs on opposite sides of the package. All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

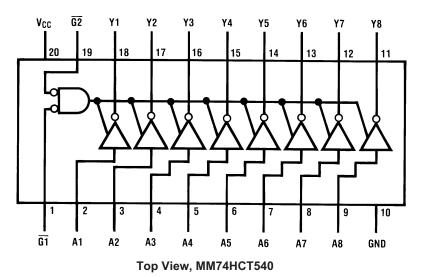
Ordering Information

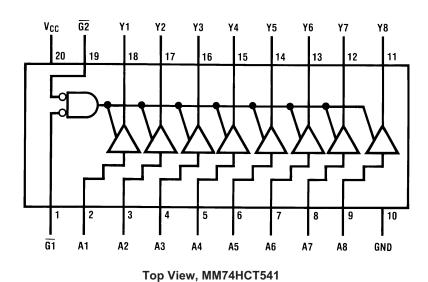
Order Number	Package Number	Package Description
MM74HCT540WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
MM74HCT540SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT540MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT541WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
MM74HCT541SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT541MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT541N	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering number.

Connection Diagrams

Pin Assignments for DIP, SOIC, SOP and TSSOP





Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5 to +7.0V
V _{IN}	DC Input Voltage	–1.5 to V _{CC} +1.5V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} +0.5V
I _{IK} , I _{OK}	Clamp Diode Current	±20mA
I _{OUT}	DC Output Current, per pin	±35mA
I _{CC}	DC V _{CC} or GND Current, per pin	±70mA
T _{STG}	Storage Temperature Range	–65°C to +150°C
P _D	Power Dissipation	
	Note 2	600mW
	S.O. Package only	500mW
T _L	Lead Temperature (Soldering 10 seconds)	260°C

Note:

- 1. Unless otherwise specified all voltages are referenced to ground.
- 2. Power Dissipation temperature derating plastic "N" package: -12mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	T _A Operating Temperature Range		+85	°C
t _r , t _f	Input Rise and Fall Times		500	ns

DC Electrical Characteristics

 $V_{CC} = 5V \pm 10\%$ (unless otherwise specified)

			T _A	= 25°C	T _A = -40 to 85°C	T _A = -55 to 125°C	
Symbol	Parameter	Conditions	Тур.	Gua	ranteed Li	mits	Units
V _{IH}	Minimum HIGH Level Input Voltage			2.0	2.0	2.0	V
V _{IL}	Maximum LOW Level Input Voltage			0.8	0.8	0.8	V
V _{OH}	Minimum HIGH	$V_{IN} = V_{IH}$ or V_{IL} :					
	Level Output Voltage	I _{OUT} = 20μΑ	V_{CC}	$V_{CC} - 0.1$	V _{CC} - 0.1	V _{CC} – 0.1	V
	voltage	I _{OUT} = 6.0mA, V _{CC} = 4.5V	4.2	3.98	3.84	3.7	
		I _{OUT} = 7.2mA, V _{CC} = 5.5V	5.2	4.98	4.84	4.7	
V _{OL}	Maximum LOW	$V_{IN} = V_{IH}$ or V_{IL} :					
	Level Voltage	I _{OUT} = 20μΑ	0	0.1	0.1	0.1	V
		I _{OUT} = 6.0mA, V _{CC} = 4.5V	0.2	0.26	0.33	0.4	
		$ I_{OUT} = 7.2$ mA, $V_{CC} = 5.5$ V	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current			±0.1	±1.0	±1.0	μA
l _{oz}	Maximum 3-STATE Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, $\overline{G} = V_{IH}$		±0.5	±5.0	±10	μА
I _{CC}	Maximum	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		8.0	80	160	μΑ
	Quiescent Supply Current	$V_{IN} = 2.4 V \text{ or } 0.5 V^{(3)}$	0.6	1.0	1.3	1.5	mA

Note:

3. Measured per input. All other inputs at $\rm V_{\rm CC}$ or GND.

AC Electrical Characteristics

MM74HCT540: V_{CC} = 5.0V, t_r = t_f = 6ns, T_A = 25°C, (unless otherwise specified).

Symbol	Parameter	Conditions	Тур.	Guaranteed Limits	Units
t _{PHL} , t _{PLH}	Maximum Output Propagation Delay	$C_L = 45pF$	12	18	ns
t _{PZL} , t _{PZH}	Maximum Output Enable Time	$C_L = 45 pF, R_L = 1 k\Omega$	14	28	ns
t _{PLZ} , t _{PHZ}	Maximum Output Disable Time	$C_L = 5pF, R_L = 1k\Omega$	13	25	ns

AC Electrical Characteristics

MM74HCT540: $V_{CC} = 5.0V \pm 10\%$, $t_r = t_f = 6$ ns (unless otherwise specified).

				T _A =	25°C	T _A = -40 to 85°C	T _A = -55 to 125°C	
Symbol	Parameter	Cond	litions	Тур.	G	uaranteed	Limits	Units
t _{PHL} , t _{PLH}	Maximum Output	C _L = 50pF		12	20	25	30	ns
	Propagation Delay	C _L = 150pF		22	30	38	45	
t _{PZH} , t _{PZL}	Maximum Output Enable	$R_L = 1k\Omega$	C _L = 50pF	15	30	38	45	ns
	Time		C _L = 150pF	20	40	50	60	
t _{PHZ} , t _{PLZ}	Maximum Output Disable Time	$R_L = 1k\Omega, C_L = 50pF$		15	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	C _L = 50pF		6	12	15	18	ns
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF
C _{OUT}	Maximum Output Capacitance			15	20	20	20	pF
C _{PD}	PD Power Dissipation		$\overline{G} = V_{CC}$	12				pF
	Capacitance ⁽⁴⁾		$\overline{G} = GND$	50				

Note:

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC} 2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

AC Electrical Characteristics

MM74HCT541: V_{CC} = 5.0V, t_r = t_f = 6ns, T_A = 25°C, (unless otherwise specified).

Symbol	Parameter	Conditions	Тур.	Guaranteed Limits	Units
t _{PHL} , t _{PLH}	Maximum Output Propagation Delay	C _L = 45pF	13	20	ns
t _{PZL} , t _{PZH}	Maximum Output Enable Time	$C_L = 45pF, R_L = 1k\Omega$	17	28	ns
t _{PLZ} , t _{PHZ}	Maximum Output Disable Time	$C_L = 5pF, R_L = 1k\Omega$	15	25	ns

AC Electrical Characteristics

MM74HCT541: $V_{CC} = 5.0V \pm 10\%$, $t_r = t_f = 6$ ns (unless otherwise specified).

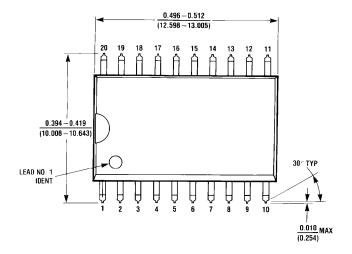
				T _A =	25°C	T _A = -40 to 85°C	T _A = -55 to 125°C	
Symbol	Parameter	Cond	litions	Тур.	G	uaranteed	Limits	Units
t _{PHL} , t _{PLH}	Maximum Output	$C_L = 50pF$		14	23	29	34	ns
	Propagation Delay	C _L = 150pF		17	33	42	49	
t _{PZH} , t _{PZL}	Maximum Output	$R_L = 1k\Omega$	C _L = 50pF	17	30	38	45	ns
	Enable Time		C _L = 150pF	22	40	50	60	
t _{PHZ} , t _{PLZ}	Maximum Output Disable Time	$R_L = 1k\Omega, C_L$	= 50pF	17	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	$C_L = 50pF$		6	12	15	18	ns
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF
C _{OUT}	Maximum Output Capacitance			15	20	20	20	pF
C _{PD}	C _{PD} Power Dissipation		$\overline{G} = V_{CC}$	12				pF
	Capacitance ⁽⁵⁾		$\overline{G} = GND$	45				

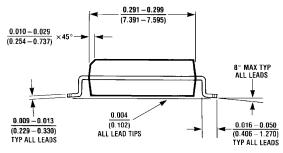
Note:

5. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC} 2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

Physical Dimensions

Dimensions are in inches (millimeters) unless otherwise noted.





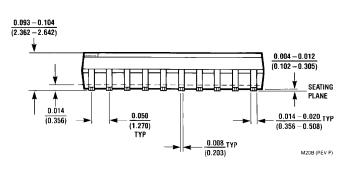
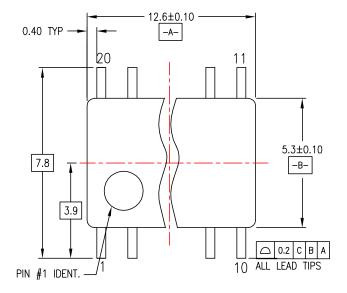
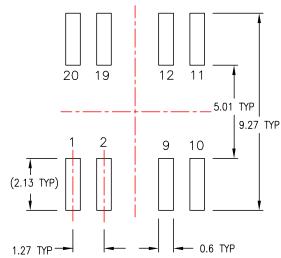


Figure 1. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Package Number M20B

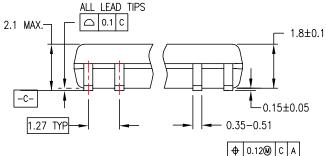
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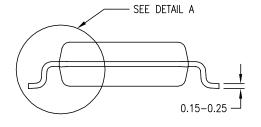
Dimensions are in millimeters unless otherwise noted.





LAND PATTERN RECOMMENDATION

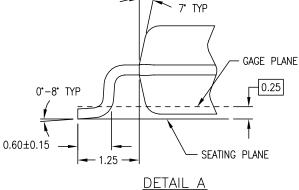




DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
 B. DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

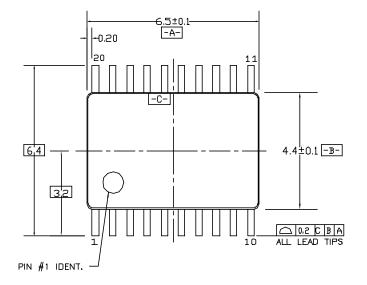


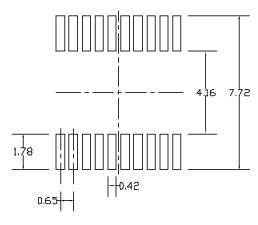
M20DREVC

Figure 2. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D

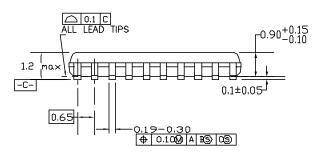
Physical Dimensions (Continued)

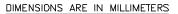
Dimensions are in millimeters unless otherwise noted.



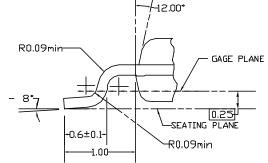


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SEE DETAIL A 0.09-0.20



DETAIL A

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REVD1

Figure 3. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

Physical Dimensions (Continued)

Dimensions are in inches (millimeters) unless otherwise noted.

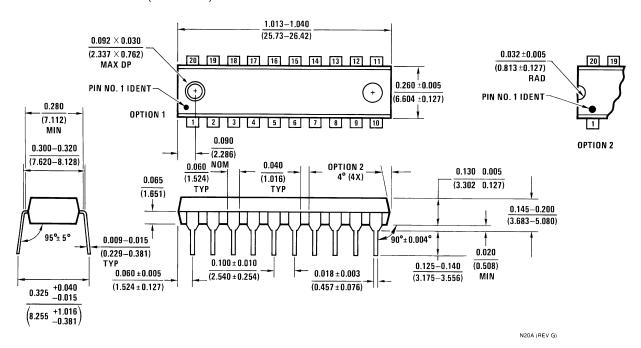


Figure 4. 20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A





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